

Institution	EAST POINT COLLEGE OF ENGINEERING AND TECHNOLOGY			
Department	ELECTRONIICS AND COMMUNICATION ENGINEERING			
Event Type / Theme Please Tick appropriate one (v)	Club Activities/ Industrial Visit/ Guest Lecture/ Invited Talk/ Workshop / FDP /Seminar / Webinar / Conference /Sports Event /NSS Activity / Cultural Event Others (Please Mention): WEBINAR			
Event Title	“Chip bus interconnect and Interfaces”			
Date	21 ST April 2023		Time	10:30 AM
Venue	: ECE SEMINAR HALL			
Duration	<u>2hrs</u>	From:	21 st April 2023	To:
Program Objective	To make the students aware of current technology in communication			
<p>A brief writeup upto 50 words providing the other details of the EVENT: Students were actively participated in Hands on session Interfaces and interconnect was topic covered in webinar to bridge gap in Digital Communication subject of sixth semester. Students were explained about the protocol ,UART and other related things inside chip. Key points in seminar were I2C, AXI architecture, Interconnect and its application.</p>				
1. Names of the Resource Persons / Chief Guests / Guests of Honors / Other’s Mention	Er Arun Patro			
2. Designation/s	Senior RTL Design Engineer			
3. Company’s Name / Associations	AMD India			
Total Number of Participants	50			
Total number of Participants in <i>Google Meet</i>	Only Resource Person			
Total number of feedbacks received through Google forms from both Google meet and You Tube	In case of virtual event			
Total Number of Views (First Day) in YouTube	In case of virtual event			
Photos				

	
Video Recording Link / YouTube Link	: (In case of virtual event)